

## DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an/the original, first and/or joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled **OLIGONUCLEOTIDES DERIVED FROM MYCOBACTERIUM FOR STIMULATING IMMUNE FUNCTION, TREATING IMMUNE-RELATED DISEASES, ATOPIC DERMATITIS AND/OR PROTECTING NORMAL IMMUNE CELL**, the specification of which was filed on May 31, 2006 as Application Serial No. 10/581,656. I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information, which is material to the patentability of this application as defined in Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or 365(b), of any foreign application(s) for patent or inventor's certificate(s), or 365(a) of any PCT international application, which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent, or inventor's certificate, or any PCT international application having a filing date before that of the application on which priority is claimed.

<u>PCT/KR2005/000266</u>	<u>PCT</u>	<u>28.01.2005</u>	<u>YES</u>
<i>Number</i>	<i>Country</i>	<i>Day/Month/Year Filed</i>	<i>Priority Claimed</i>

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under § 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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